

Single N-channel MOSFET

ELM32402LA-S

■General description

ELM32402LA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds}=20V$
- $I_d=20A$
- $R_{ds(on)} < 50m\Omega$ ($V_{gs}=5V$)
- $R_{ds(on)} < 85m\Omega$ ($V_{gs}=2.5V$)

■Maximum absolute ratings

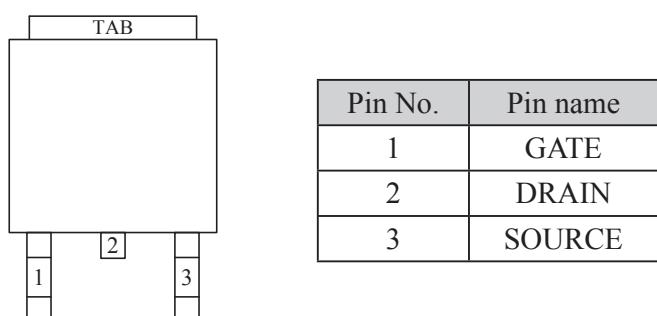
Parameter	Symbol	Limit	Unit	Note
Gate-source voltage	V_{gs}	± 16	V	
Continuous drain current	I_d	20	A	3
		13		
Pulsed drain current	I_{dm}	40	A	3
Power dissipation	P_d	26	W	
		11		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

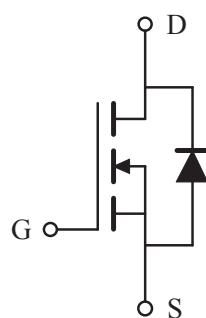
Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-case	$R_{\theta jc}$		4.8	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$		110.0	°C/W	

■Pin configuration

TO-252-3(TOP VIEW)



■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BV _{dss}	I _d =250μA, V _{gs} =0V	20			V	
Zero gate voltage drain current	I _{dss}	V _{ds} =16V, V _{gs} =0V			1	μA	
		V _{ds} =13.2V, V _{gs} =0V, T _j =125°C			10		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±16V			±100	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =250μA	0.45	0.75	1.00	V	
On state drain current	I _{d(on)}	V _{gs} =4.5V, V _{ds} =10V	20			A	1
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =5V, I _d =6A		37	50	mΩ	1
		V _{gs} =2.5V, I _d =5A		55	85	mΩ	
Forward transconductance	G _{fs}	V _{ds} =10V, I _d =6A		13		S	1
Diode forward voltage	V _{sd}	I _f =I _s , V _{gs} =0V			1.3	V	1
Max. body-diode continuous current	I _s				20	A	
Pulsed body-diode current	I _{sm}				40	A	3
DYNAMIC PARAMETERS							
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =15V, f=1MHz		195		pF	
Output capacitance	C _{oss}			125		pF	
Reverse transfer capacitance	C _{rss}			50		pF	
SWITCHING PARAMETERS							
Total gate charge	Q _g	V _{gs} =5V, V _{ds} =10V, I _d =10A		7.5		nC	2
Gate-source charge	Q _{gs}			0.9		nC	2
Gate-drain charge	Q _{gd}			4.0		nC	2
Turn-on delay time	t _{d(on)}	V _{gs} =5V, V _{ds} =10V, I _d ≈1A R _l =1Ω, R _{gen} =3.3Ω		4.5		ns	2
Turn-on rise time	t _r			49.5		ns	2
Turn-off delay time	t _{d(off)}			12.0		ns	2
Turn-off fall time	t _f			6.0		ns	2

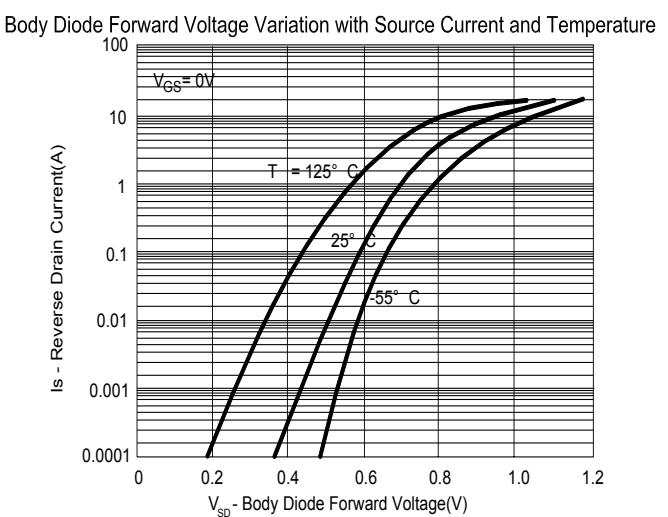
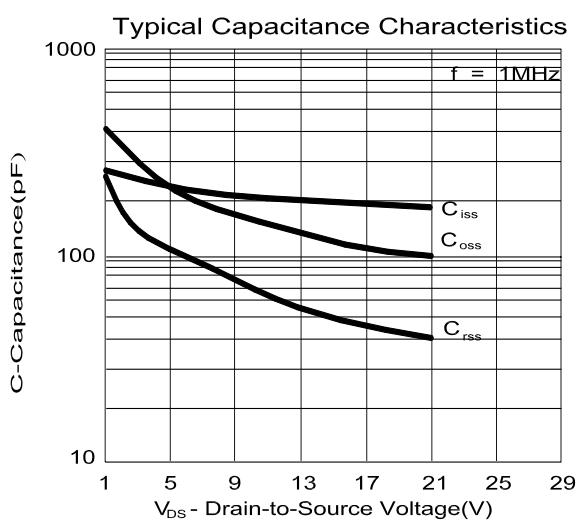
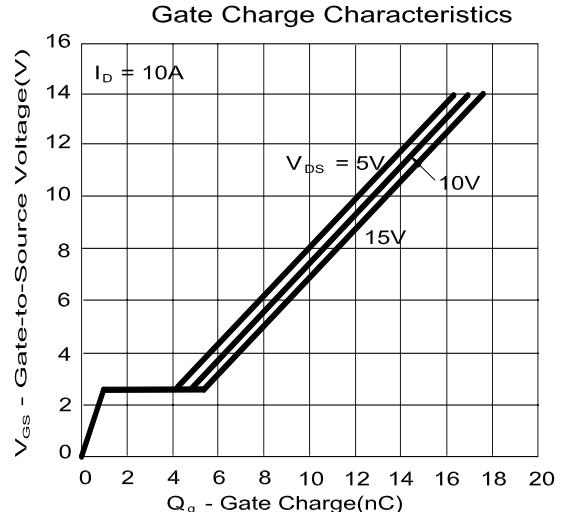
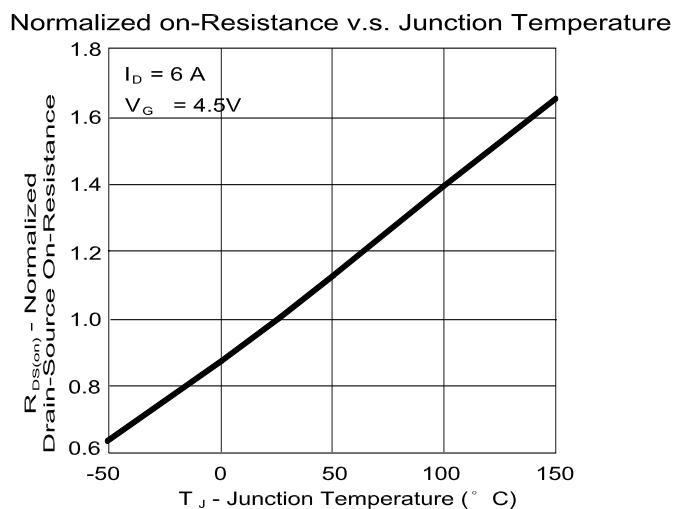
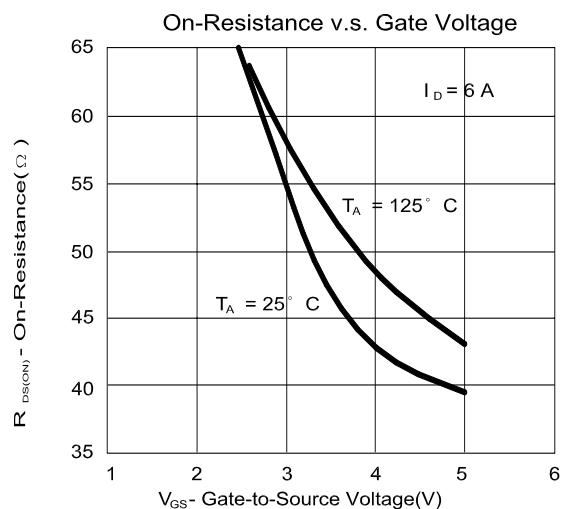
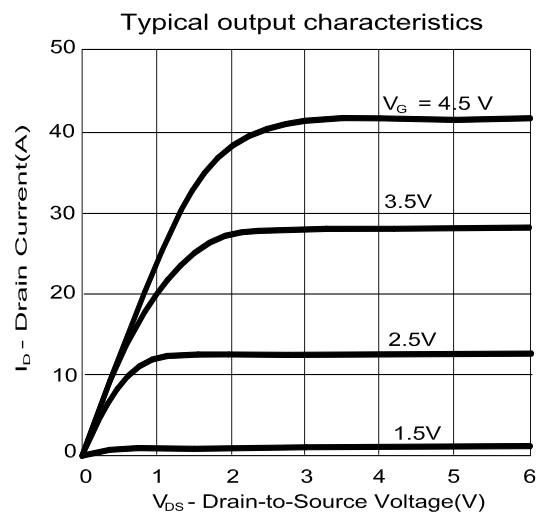
NOTE :

1. Pulse test : Pulsed width ≤ 300μsec and Duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulsed width limited by maximum junction temperature.
4. Duty cycle ≤ 1%.

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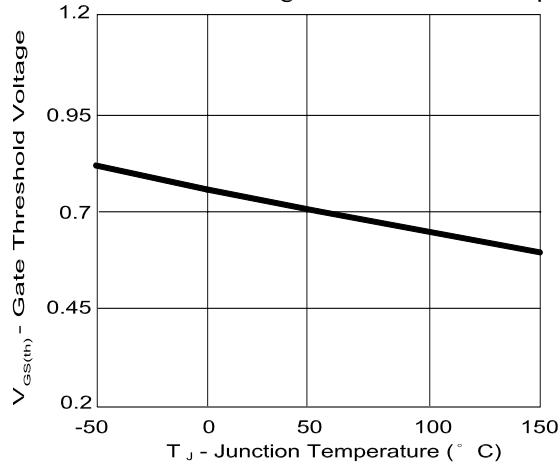
■ Typical electrical and thermal characteristics



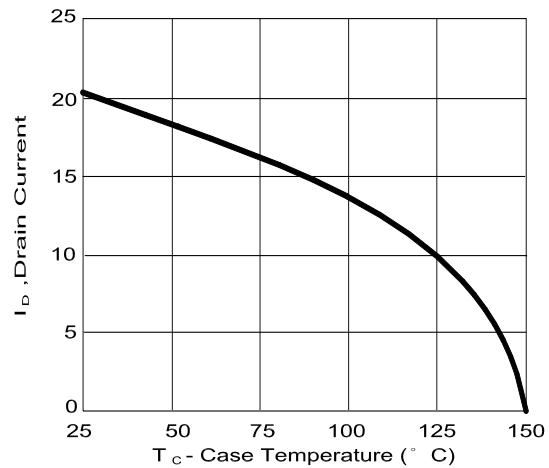
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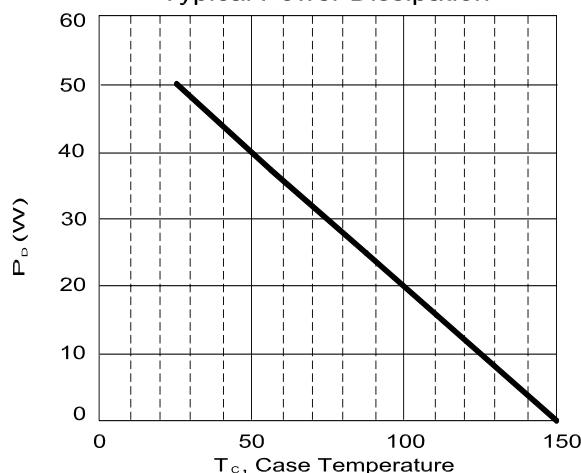
Gate Threshold Voltage v.s. Junction Temperature



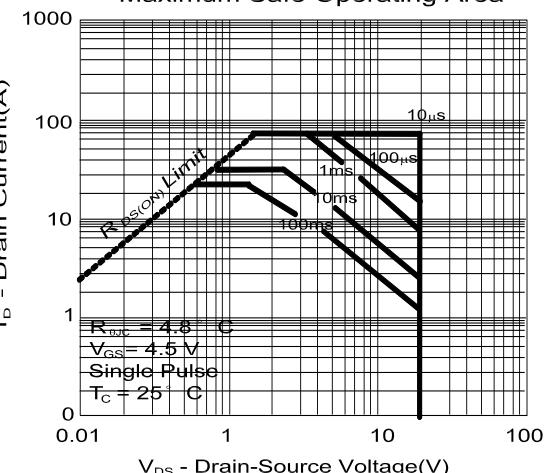
Maximum Drain Current v.s. Case Temperature



Typical Power Dissipation



Maximum Safe Operating Area



Normalized Thermal Response($R_{th(jc)}$)

Effective Transient Thermal Impedance

